



RoHS Compliant

REV	MODIFICATION	DATE	DRAW
A0	Release To Production	2010.01.19	Abel
A1	Release To ECN20110809	2011.09.09	Ivy
A2	Release To ECN20130208	2013.03.07	Seven

Specification

- 1.Current Rating:7A
- 2.Voltage Rating:250V AC/DC
- 3.Contact Resistance:10mΩ Max.
- 4.Insulation Resistance:1000MΩ Min. At DC 500V
- 5.Dielectric Withstanding Voltage:1500 VAC/Minute
- 6.Operating Temperature:-25°C~+85°C

Material:

- 1.Housing:Thermoplastic UL94V-2
- 2.Contact Pin:Copper Alloy SQ Pin=1.14mm

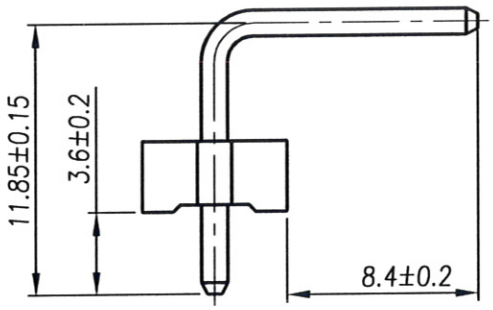
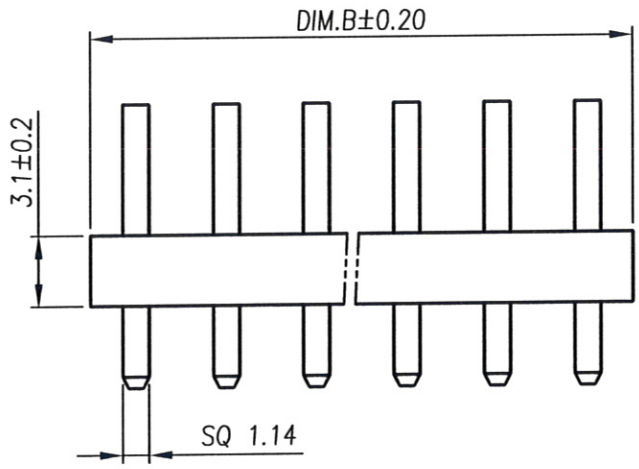
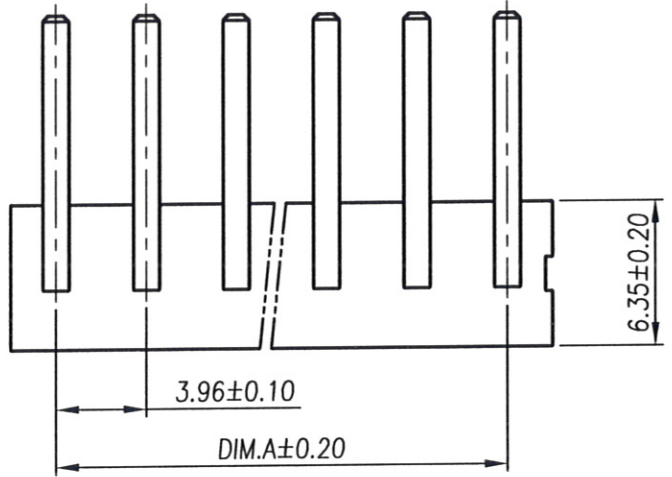
Finish:

- 1.Housing:Natural
- 2.Contact Pin:Bright Tin Plated Over Ni

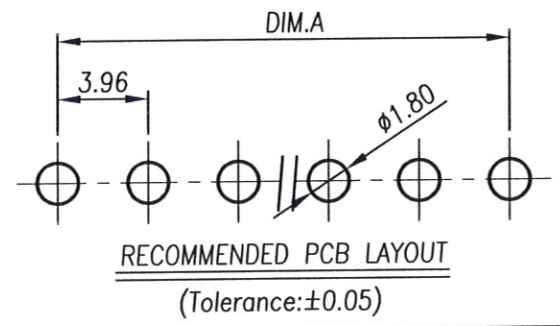
Part No.: AD02117 XX 0 1 5 2


Number of Pin      Packing  
 02~16                      5:Bag

Housing Material      Plating  
 0:NY66 UL94V-2 Natural      1:Bright Tin Plated Over Ni



Pin	DIM.A	DIM.B	Pin	DIM.A	DIM.B
02	3.96	8.0	10	35.64	39.9
03	7.92	12.0	11	39.60	43.9
04	11.88	15.9	12	43.56	47.8
05	15.84	20.0	13	47.52	51.8
06	19.80	24.0	14	51.48	55.7
07	23.76	27.9	15	55.44	59.8
08	27.72	31.9	16	59.40	63.8
09	31.68	35.8			





## 金上達科技股份有限公司

**GOLDENSUNDA TECHNOLOGY CO.,LTD**

TOLERANCE UNLESS OTHERWISE SPECIFIED		PROJ.	TITLE: Wire To Board Wafer 3.96mm 90° DIP	
.x± 0.35	x.'± 2'	APR. Jay 20130307	PART NO. AD02117XX0152	DWG NO. AD02117XX0152
.xx± 0.25	.x'± 1'	CHK. Michelle 20130307	CUSTOMER DRAWING	
.xxx± 0.15	.xx'± 0.5'	DRA. Seven 20130307	UNITS: mm	SCALE 3:1
		SIZE: <b>A4</b>	SHEET 1 / 1	REV A2